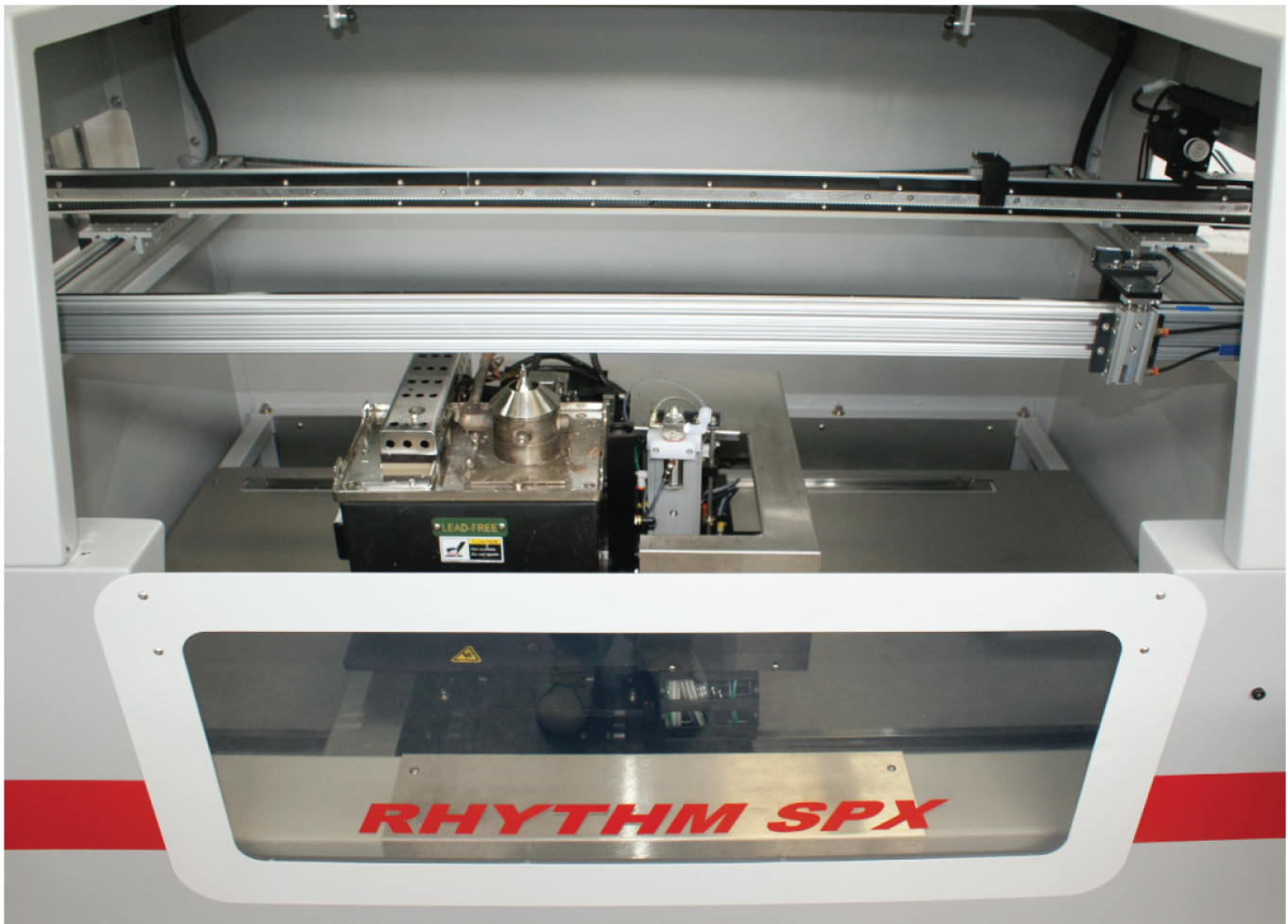




RPS
BE SELECTIVE™



Rhythm SPX

Selective Soldering System

The SPX Selective Soldering System handles basic to complex dip, drag, wire bond, and other through-hole soldering processes. The SPX features best-in-class servo motor motion control for speed, accuracy, and repeatability. The nitrogen inertion process uses closed loop temperature control for superior thermal performance. Innovative miniwave nozzle designs provide wave stability and defect free performance. The SPX system utilizes a graphical interface for simple programming and operation.

Rhythm SPX

Selective Soldering System

Operation

X/Y/Z Control Closed Loop Servo Motors
 Max Process Range 24 x 24" | 600 x 600 mm
 Min/Max PCB Size 1 x 3" to 24 x 24" | 25 x 75 mm to 600 x 600 mm
 Computer & Monitor Windows 7 PC | Offline RPS CamConductor™ Programming

Solder Process Control

Load Method Manual (Inline SMEMA Auto-Load Option) | Universal PCB Holder
 Nozzle Material Wetted Chromium Alloy
 Nozzle Sizes 1.5 - 20 mm & Custom
 Keep Away 1.5 mm Standard | 0.5 mm Capable
 Max Wave Height 6 mm Standing Wave Height

Flux Process Control

Spray Flux Standard | Stainless Steel EFD™ | 3 – 30 mm
 Flux Capacity 1 Liter Pressurized
 Drop Jet Flux* Option
 Dual Chemistry* Option

Solder Pot Management

Solder Pot Capacity 35 lbs | 16 kgs
 Temp Control PID Proportioning (0-400°C) ± 2°C
 Heat Time 45 Minutes
 Dross Production 1.5 Ounces Per 8 Hours

Nitrogen Management

N2 Inertion RPS DirectHeat™
 N2 Temp Control 0-500 °C Closed Loop Set Point
 Consumption 30 SCFH (ft³) | 0.85 CMH (m³)
 Required Purity <20 PPM O2H

Facilities

Footprint 63 x 64 x 49" | 1600 x 625 x 1145 mm
 Weight 1100 lbs | 500 kgs

